PRELIMINARY SPEC

Part Number: WP7676CSEC/J HY

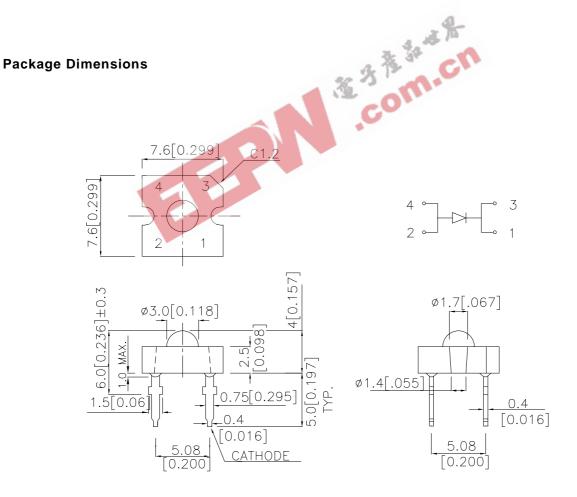
HYPER ORANGE

Features

- •SUPER FLUX OUTPUT.
- •DESIGN FOR HIGH CURRENT OPERATION.
- OUTSTANDING MATERIAL EFFICIENCY.
- •RELIABLE AND RUGGED.
- ●RoHS COMPLIANT.

Description

The Super Bright device is based on a light emitting diode chip made from AlGaInP and bonded on silicon substrate.



Notes

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25 (0.01\mbox{"})$ unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

 SPEC NO: DSAG3763
 REV NO: V.2
 DATE: JUN/16/2006
 PAGE: 1 OF 4

 APPROVED: J. Lu
 CHECKED: Allen Liu
 DRAWN: Y.L.LI
 ERP:1101016237

Kingbright

Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [5] @ 20mA *70mA		Viewing Angle [1]
			Min.	Тур.	201/2
WP7676CSEC/J	HYPER ORANGE (AlGainP)	WATER CLEAR	1800	2800	70°
			*5700	*9000	

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
- 2. * Luminous intensity with asterisk is measured at 70mA under 40ms pulse width.
- 3.Drive current between 10mA and 30mA are recommended for long term performance.
 4.Operation at current below 10mA is not recommended.
 5. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Orange	640		nm	IF=20mA
λD[1]	Dominant Wavelength	Hyper Orange	630	4 34 10	nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Orange	25	3	nm	IF=20mA
С	Capacitance	Hyper Orange	27	3140	pF	VF=0V;f=1MHz
VF[2]	Forward Voltage	Hyper Orange	2.2	2.8	V	IF=20mA
lr	Reverse Current	Hyper Orange		10	uA	VR = 5V

Notes:

- 1.Wavelength: +/-1nm. 2.Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at Ta=25°C

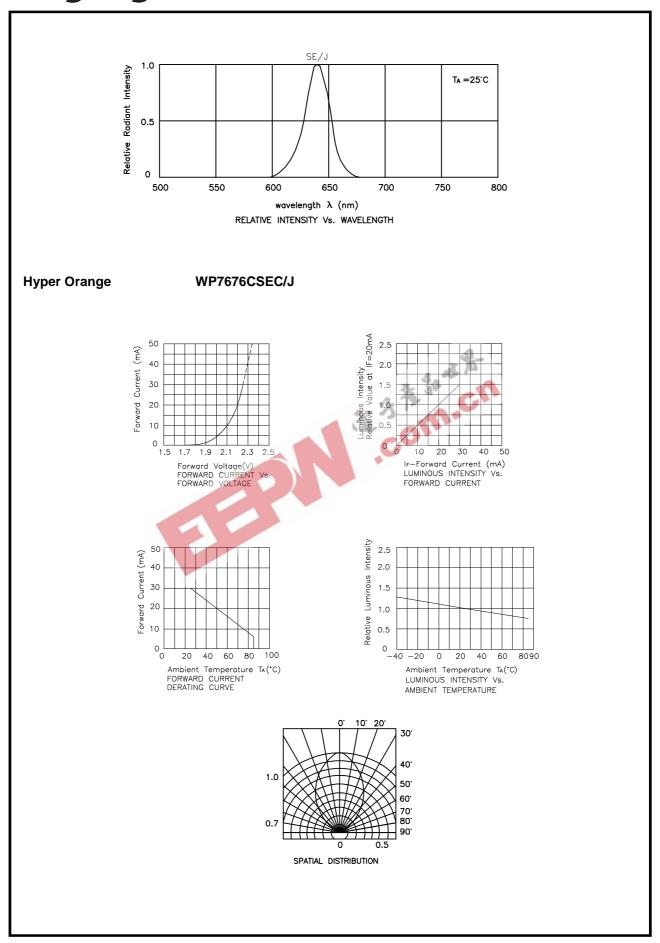
Parameter	Hyper Orange	Units
Power dissipation	84	mW
DC Forward Current	30	mA
Peak Forward Current [1]	150	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	
Lead Solder Temperature [2] 260°C For 3 Seconds		
Lead Solder Temperature [3] 260°C For 5 Seconds		

Notes:

- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 2. 2mm below package base.
- 3. 5mm below package base.

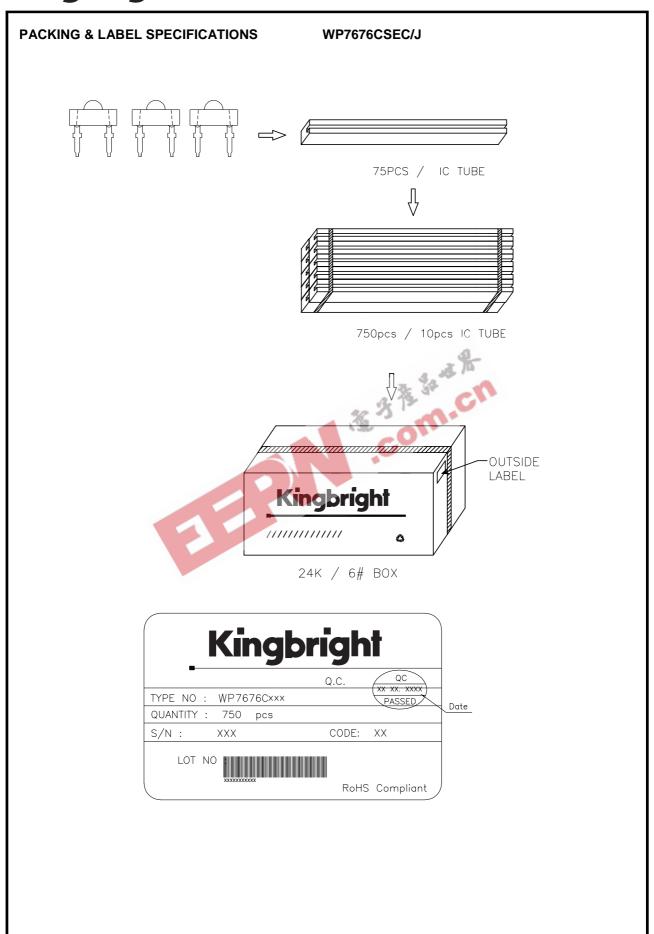
SPEC NO: DSAG3763 **REV NO: V.2 DATE: JUN/16/2006** PAGE: 2 OF 4 APPROVED: J. Lu CHECKED: Allen Liu DRAWN: Y.L.LI ERP:1101016237

Kingbright



SPEC NO: DSAG3763 REV NO: V.2 DATE: JUN/16/2006 PAGE: 3 OF 4
APPROVED: J. Lu CHECKED: Allen Liu DRAWN: Y.L.LI ERP:1101016237

Kingbright



 SPEC NO: DSAG3763
 REV NO: V.2
 DATE: JUN/16/2006
 PAGE: 4 OF 4

 APPROVED: J. Lu
 CHECKED: Allen Liu
 DRAWN: Y.L.LI
 ERP:1101016237